## SiHH21N60EF



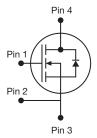
Vishay Siliconix

## **E Series Power MOSFET with Fast Body Diode**

| PRODUCT SUMMARY                            |                              |  |  |  |  |
|--|------------------------------|--|--|--|--|
| V <sub>DS</sub> (V) at T <sub>J</sub> max. | 650                          |  |  |  |  |
| R <sub>DS(on)</sub> typ. (Ω) at 25 °C      | V <sub>GS</sub> = 10 V 0.161 |  |  |  |  |
| Q <sub>g</sub> max. (nC)                   | 86                           |  |  |  |  |
| Q <sub>gs</sub> (nC)                       | 13                           |  |  |  |  |
| Q <sub>gd</sub> (nC)                       | 23                           |  |  |  |  |
| Configuration                              | Single                       |  |  |  |  |

### PowerPAK<sup>®</sup> 8 x 8





N-Channel MOSFET

### FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

| ORDERING INFORMATION            |                    |
|---------------------------------|--------------------|
| Package                         | PowerPAK 8 x 8     |
| Lead (Pb)-free and Halogen-free | SiHH21N60EF-T1-GE3 |

| <b>ABSOLUTE MAXIMUM RATINGS</b>                    | $(T_C = 25 \ ^\circ C, un$ | less otherwis           | se noted)                         |             |       |
|--|----------------------------|-------------------------|-----------------------------------|-------------|-------|
| PARAMETER  |                            |                         | SYMBOL                            | LIMIT       | UNIT  |
| Drain-Source Voltage                               |                            |                         | V <sub>DS</sub>                   | 600         | v     |
| Gate-Source Voltage                                |                            |                         | V <sub>GS</sub>                   | ± 30        | v     |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | V <sub>GS</sub> at 10 V    | T <sub>C</sub> = 25 °C  | - I <sub>D</sub>                  | 19          |       |
|  | VGS AL TO V                | T <sub>C</sub> = 100 °C |                                   | 12          | А     |
| Pulsed Drain Current <sup>a</sup>                  |                            |                         | I <sub>DM</sub>                   | 47          |       |
| Linear Derating Factor                             |                            |                         |                                   | 1.4         | W/°C  |
| Single Pulse Avalanche Energy <sup>b</sup>         |                            |                         | E <sub>AS</sub>                   | 226         | mJ    |
| Maximum Power Dissipation                          |                            |                         | PD                                | 174         | W     |
| Operating Junction and Storage Temperature Range   |                            |                         | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C    |
| Drain-Source Voltage Slope                         | T <sub>J</sub> =           | T <sub>J</sub> = 125 °C |                                   | 70          | 1//22 |
| Reverse Diode dV/dt c                              |                            |                         | dV/dt                             | 20          | V/ns  |

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4 A.

c.  $I_{SD} \leq I_D,\, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT

HALOGEN

FREE



Vishay Siliconix

| THERMAL RESISTANCE RATI                                    | NGS                   |  |   |                         |      |       |       |      |
|--|-----------------------|--|---|-------------------------|------|-------|-------|------|
| PARAMETER  | SYMBOL                | TYP.   |   | MAX.                    |      | UNIT  |       |      |
| Maximum Junction-to-Ambient                                | R <sub>thJA</sub>     | 40   | 52  |                         |      | 0044  |       |      |
| Maximum Junction-to-Case (Drain)                           | R <sub>thJC</sub>     | 0.55 0.72  |   |                         |      | °C/W  |       |      |
|  |                       |  | -   |                         |      |       |       |      |
| <b>SPECIFICATIONS</b> ( $T_J = 25 \degree C$ , u           | Inless otherwi        | se noted)  |   |                         |      |       |       |      |
| PARAMETER  | SYMBOL                | 1  | T CONDITI   | ONS                     | MIN. | TYP.  | MAX.  | UNIT |
| Static   |                       |  |   |                         |      |       |       |      |
| Drain-Source Breakdown Voltage                             | V <sub>DS</sub>       | V <sub>GS</sub> =  | = 0 V, I <sub>D</sub> = 2   | 50 µA                   | 600  | -     | -     | V    |
| V <sub>DS</sub> Temperature Coefficient                    | $\Delta V_{DS}/T_{J}$ | Reference  | e to 25 °C, I   | <sub>D</sub> = 10 mA    | -    | 0.63  | -     | V/°C |
| Gate-Source Threshold Voltage (N)                          | V <sub>GS(th)</sub>   | V <sub>DS</sub> =  | $V_{GS}$ , $I_D = 2$  | 50 µA                   | 2.0  | -     | 4.0   | V    |
| Cata Sauraa Laakaga  |                       | , v  | $V_{\rm GS} = \pm 20$ V   | V                       | -    | -     | ± 100 | nA   |
| Gate-Source Leakage  | I <sub>GSS</sub>      | , v  | / <sub>GS</sub> = ± 30 \  | V                       | -    | -     | ± 1   | μA   |
| Zaro Cata Valtaga Drain Current                            |                       | V <sub>DS</sub> =  | 480 V, V <sub>GS</sub>  | = 0 V                   | -    | -     | 1     |      |
| Zero Gate Voltage Drain Current                            | I <sub>DSS</sub>      | V <sub>DS</sub> = 480 V  | , V <sub>GS</sub> = 0 V,  | T <sub>J</sub> = 125 °C | -    | -     | 100   | μA   |
| Drain-Source On-State Resistance                           | R <sub>DS(on)</sub>   | V <sub>GS</sub> = 10 V   | I <sub>D</sub>  | = 11 A                  | -    | 0.161 | 0.185 | Ω    |
| Forward Transconductance                                   | 9 <sub>fs</sub>       | V <sub>DS</sub> = 30 V, I <sub>D</sub> = 11 A  |   | -                       | 7.3  | -     | S     |      |
| Dynamic  |                       |  |   |                         |      |       |       |      |
| Input Capacitance  | C <sub>iss</sub>      |  | $V_{GS} = 0 V,$   |                         | -    | 2035  | -     | _    |
| Output Capacitance   | C <sub>oss</sub>      | ,  | V <sub>DS</sub> = 100 V   | ,                       | -    | 96    | -     |      |
| Reverse Transfer Capacitance                               | C <sub>rss</sub>      | f = 1 MHz  |   | -                       | 6    | -     | pF    |      |
| Effective Output Capacitance, Energy Related <sup>a</sup>  | C <sub>o(er)</sub>    | $V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V  |   | -                       | 60   | -     |       |      |
| Effective Output Capacitance, Time<br>Related <sup>b</sup> | C <sub>o(tr)</sub>    |  |   | -                       | 257  | -     |       |      |
| Total Gate Charge  | Qg                    |  | V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V |                         | -    | 57    | 86    | nC   |
| Gate-Source Charge   | $Q_gs$                | $V_{GS} = 10 V$  |   |                         | -    | 13    | -     |      |
| Gate-Drain Charge  | Q <sub>gd</sub>       |  |   |                         | -    | 23    | -     | 1    |
| Turn-On Delay Time   | t <sub>d(on)</sub>    |  |   | -                       | 20   | 40    |       |      |
| Rise Time  | t <sub>r</sub>        | V <sub>DD</sub> =  | 480 V, I <sub>D</sub> =   | 11 A,                   | -    | 43    | 86    | ns   |
| Turn-Off Delay Time  | t <sub>d(off)</sub>   | V <sub>GS</sub> =  | $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$                   |                         | -    | 65    | 98    | 115  |
| Fall Time  | t <sub>f</sub>        |  |   | -                       | 43   | 86    |       |      |
| Gate Input Resistance                                      | R <sub>g</sub>        | f = 1 MHz, open drain  |   | 0.25                    | 0.8  | 1.0   | Ω     |      |
| Drain-Source Body Diode Characteristic                     | cs                    |  |   |                         |      |       |       |      |
| Continuous Source-Drain Diode Current                      | I <sub>S</sub>        | MOSFET symbol<br>showing the<br>integral reverse<br>p - n junction diode               |   | -                       | -    | 19    | A     |      |
| Pulsed Diode Forward Current                               | I <sub>SM</sub>       |  |   | -                       | -    | 47    |       |      |
| Diode Forward Voltage                                      | V <sub>SD</sub>       | T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V                   |   | -                       | 0.9  | 1.2   | V     |      |
| Reverse Recovery Time                                      | t <sub>rr</sub>       | _  |   |                         | -    | 137   | 274   | ns   |
| Reverse Recovery Charge                                    | Q <sub>rr</sub>       | $T_J = 25 \ ^{\circ}C, I_F = I_S = 11 \ A,$<br>dI/dt = 100 A/µs, V <sub>R</sub> = 25 V |   | -                       | 0.8  | 1.6   | μC    |      |
| Reverse Recovery Current                                   | I <sub>RRM</sub>      |  |   | -                       | 12   | -     | А     |      |

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

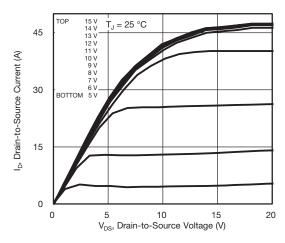


Fig. 1 - Typical Output Characteristics

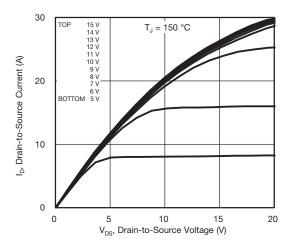
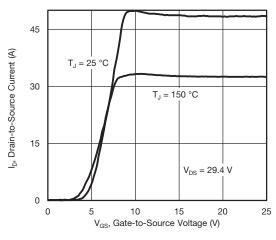


Fig. 2 - Typical Output Characteristics





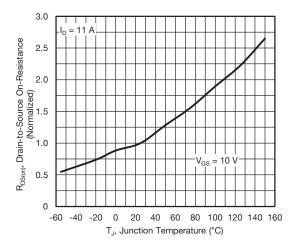


Fig. 4 - Normalized On-Resistance vs. Temperature

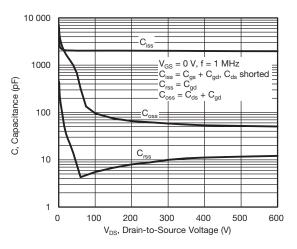


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

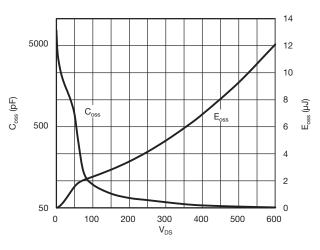


Fig. 6 -  $C_{\text{OSS}}$  and  $E_{\text{OSS}}$  vs.  $V_{\text{DS}}$ 

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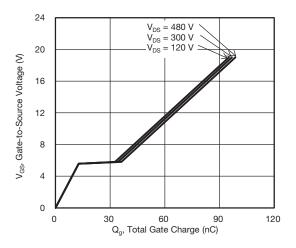


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

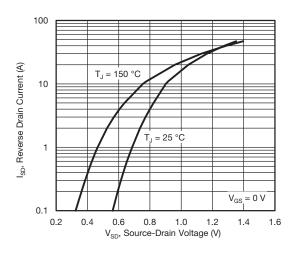


Fig. 8 - Typical Source-Drain Diode Forward Voltage

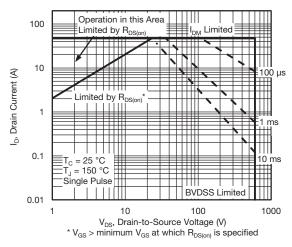


Fig. 9 - Maximum Safe Operating Area

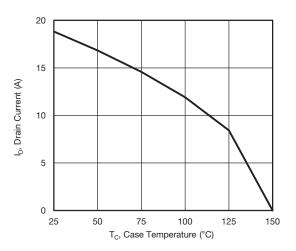


Fig. 10 - Maximum Drain Current vs. Case Temperature

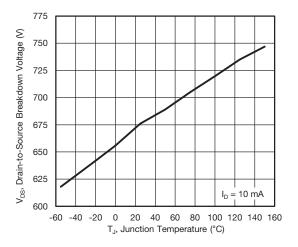


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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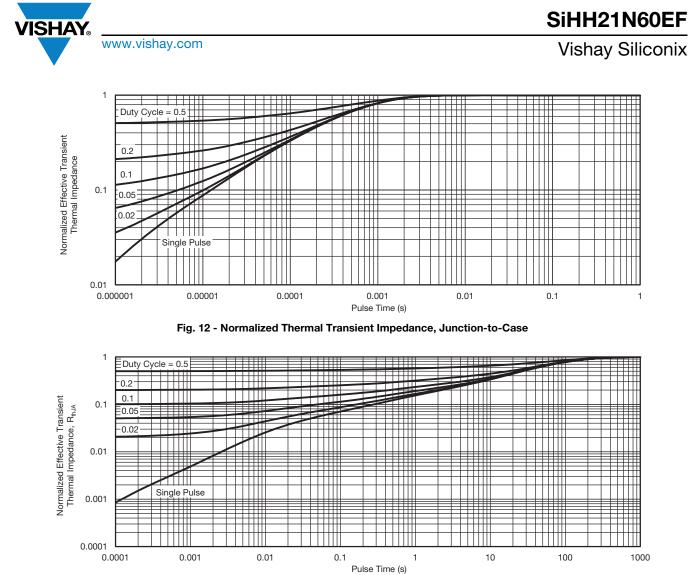


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

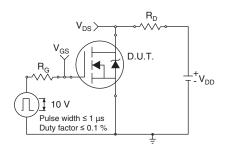


Fig. 14 - Switching Time Test Circuit

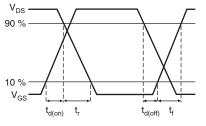


Fig. 15 - Switching Time Waveforms

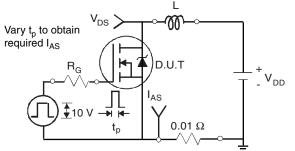


Fig. 16 - Unclamped Inductive Test Circuit

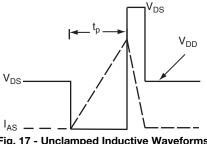
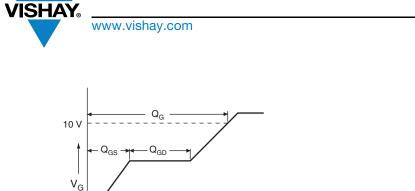


Fig. 17 - Unclamped Inductive Waveforms

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Charge -----

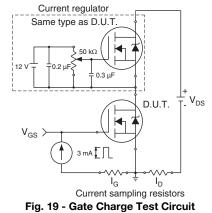
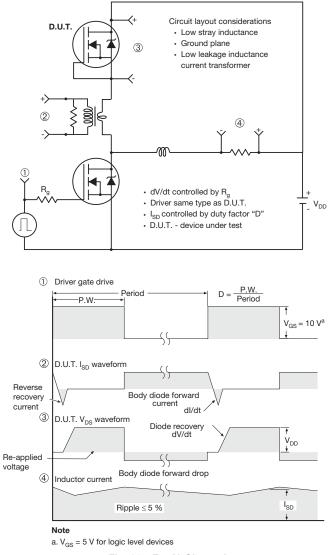


Fig. 18 - Basic Gate Charge Waveform





#### Fig. 20 - For N-Channel

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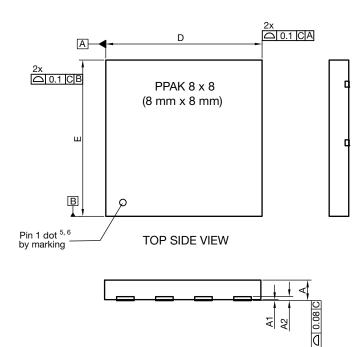
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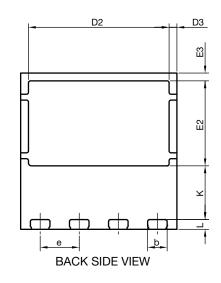
SiHH21N60EF



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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





| DIM              | MILLIMETERS |          |           | INCHES    |            |       |  |
|------------------|-------------|----------|-----------|-----------|------------|-------|--|
| DIM.             | MIN.        | NOM.     | MAX.      | MIN.      | NOM.       | MAX.  |  |
| А                | 0.95        | 1.00     | 1.05      | 0.037     | 0.039      | 0.041 |  |
| A1               | 0.00        | -        | 0.05      | 0.000     | -          | 0.002 |  |
| A2               |             | 020 ref. |           |           | 0.008 ref. |       |  |
| b                | 0.95        | 1.00     | 1.05      | 0.037     | 0.039      | 0.041 |  |
| D                | 7.90        | 8.00     | 8.10      | 0.311     | 0.315      | 0.319 |  |
| D2               | 7.10        | 7.20     | 7.30      | 0.280     | 0.283      | 0.287 |  |
| D3               | 0.40 BSC    |          |           | 0.016 BSC |            |       |  |
| е                | 2.00 BSC    |          | 0.079 BSC |           |            |       |  |
| E                | 7.90        | 8.00     | 8.10      | 0.311     | 0.315      | 0.319 |  |
| E2               | 4.30        | 4.35     | 4.40      | 0.169     | 0.171      | 0.173 |  |
| E3               | 0.40 BSC    |          |           |           | 0.016 BSC  |       |  |
| К                | 2.75 BSC    |          | 0.108 BSC |           |            |       |  |
| L                | 0.45        | 0.50     | 0.55      | 0.018     | 0.020      | 0.022 |  |
| N <sup>(3)</sup> | 8           |          |           |           | 8          |       |  |

### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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